

# **10-BIT, TWO PORT BUS SWITCH**

### **IDT74FST3861 PRODUCT PREVIEW**

# FEATURES:

OE

- Bus switches provide zero delay paths •
- Extended commercial range of -40°C to +85°C
- Low switch on-resistance: •  $FST3xxx - 5\Omega$ FST32xxx –28Ω
- TTL-compatible input and output levels
- ESD >2000v per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- Available in SOIC, QSOP and TSSOP

FUNCTIONAL BLOCK DIAGRAM

# **DESCRIPTION:**

The FST3861 belongs to IDT's family of Bus switches. Bus switch devices perform the function of connecting or isolating two ports without providing any inherent current sink or source capability. They generate little or no noise of their own while providing a low resistance path for an external driver. These devices connect input and output ports through an n-channel FET. When the gate-to source junction of this FET is adequately forward-biased, the device conducts and the resistance between input and output ports is small. Without adequate bias on the gate-to-source junction of the FET, the FET is turned off, therefore with no VCC applied, the device has not insertion capability.

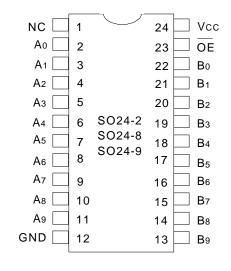
The low on-resistance and simplicity of the connection between input and output ports reduces the delay in this path to close to zero.

# PIN DESCRIPTION

Pin Names Description	
ŌĒ	Output Enable Input (Active LOW)
Ax	A Port Bits
Bx	B Port Bits

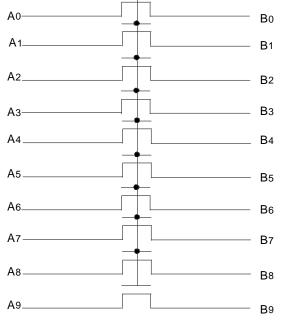
4246 tbl 01

# PIN CONFIGURATION



4246 drw 02

SOIC/QSOP/TSSOP **TOP VIEW** 



4246 drw 01

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#### COMMERCIAL TEMPERATURE RANGE

# ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max.	Unit	
VTERM <sup>(2)</sup>	Terminal Voltage with Respect to GND	-0.5 to +7.0	V	
TSTG	Storage Temperature	-65 to +150	°C	
Ιουτ	Maximum Continuous Channel Current	128	mA	
NOTES: 4246 tbl (				

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc, Control and Switch terminals

#### **FUNCTION TABLE**

Inputs	
ŌĒ	Outputs
L	Connect A to B
Н	Disconnect A from B
	4246 tbl 03

CAPACITANCE<sup>(1)</sup>

Symbol	Parameter	Conditions <sup>(2)</sup>	Тур.	Unit
CIN	Control Input Capacitance		8	pF
Ci/O	Switch Input/Output Capacitance	Switch Off	13	pF
4246 tbl 04				

NOTES:

1. Capacitance is characterized but not tested.

2. TA = 25°C, f = 1MHz, VIN = 0V, VOUT = 0V

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Condition Apply Unless Otherwise Specified:

Commercial:  $TA = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $VCC = 5.0V \pm 10\%$ 

Symbol	Parameter	Test Conditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
Vih	Control Input HIGH Voltage	Guaranteed Logic HIGH Level		2.0	_		V
VIL	Control Input LOW Voltage	Guaranteed Logic LO	W Level	_	—	0.8	V
Ін	Control Input HIGH Current	Vcc = Max.	VI = VCC	_	—	±1	μA
lı∟	Control Input LOW Current		VI = GND	_	—	±1	
lozн	Current During	Vcc = Max., Vo = 0 to 5V		_	—	±1	μA
Iozl	Bus Switch DISCONNECT			_	—	±1	
Vik	Clamp Diode Voltage	Vcc = Min., IIN = -18mA		_	-0.7	-1.2	V
IOFF	Switch Power Off Leakage	Vcc = 0V, VIN or Vo $\leq$ 5.5V		_	—	±1	μA
Icc	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc		_	0.1	3	μA

4246 tbl 05

# **BUS SWITCH IMPEDANCE OVER OPERATING RANGE**

Following Condition Apply Unless Otherwise Specified: Commercial: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, VCC =  $5.0V \pm 10\%$ 

Symbol	Parameter	Test Conditions	Min.	Typ. <sup>(1)</sup>	Max.	Unit
Ron	Switch On Resistance <sup>(2)</sup>	VCC = Min., VIN = 0.0V	—	5	7	Ω
		ION = 48mA				
		Vcc = Min., VIN = 2.4V	_	10	15	
		ION = 15mA				
los	Short Circuit Current, A to B <sup>(3)</sup>	A(B) = 0V, B(A) = Vcc	100	_	—	mA
NOTES			•	•	. 4	246 tbl 06

NOTES:

1. Typical values are at Vcc = 5.0V, +25°C ambient.

2. The voltage drop between the indicated ports divided by the current through the switch.

3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

# **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Conditions <sup>(1)</sup>		Min.	Typ. <sup>(2)</sup>	Max.	Unit
∆lcc	Quiescent Power Supply Current	Vcc = Max.		—	0.5	1.5	mA
	TTL Inputs HIGH	$VIN = 3.4V^{(3)}$					
ICCD	Dynamic Power Supply	Vcc = Max.	VIN = VCC	—	0.3	0.4	mA/
	Current <sup>(4,5)</sup>	Outputs Open	VIN = GND				MHz/
		1 Enable Pin Toggling					Enable
		50% Duty Cycle					
lc	Total Power Supply Current <sup>(6)</sup>	Vcc = Max.	VIN = VCC	_	3.0	4.0	mA
		Outputs Open	VIN = GND				
		1 Enable Pin Toggling					
		fi = 10MHz	VIN = 3.4	<u> </u>	3.3	4.8	
		50% Duty Cycle	VIN = GND				

#### NOTES:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ 

2. Typical values are at Vcc = 5.0V, +25°C ambient.

3. Per TTL driven input (VIN = 3.4V). All other inputs at Vcc or GND. Switch inputs do not contribute to  $\Delta$ Icc.

4. This parameter represents the current required to switch the internal capacitance of the control inputs at the specified frequency. Switch inputs generate no significant power supply currents as they transition. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.

- 5. CPD = ICCD/VCC
- CPD = Power Dissipation Capacitance
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
  - $IC = ICC + \Delta ICC DHNT + ICCD$  (fiN)
  - Icc = Quiescent Current
  - $\Delta$ ICC = Power Supply Current for a TTL High Input (VIN = 3.4V)
  - DH = Duty Cycle for TTL Inputs High
  - NT = Number of TTL Inputs at DH
  - ICCD = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
  - fi = Control Input Frequency
  - N = Number of Control Inputs Toggling at fi

# SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Following Condition Apply Unless Otherwise Specified:

Commercial: TA = -40°C to +85°C, VCC = 5.0V ±10%

Symbol	Description <sup>(1)</sup>	Min.	Тур.	Max.	Unit
tPLH	Data Propagation Delay	_	—	0.25	ns
<b>t</b> PHL	A to B, B to $A^{(2)}$				
tPZH	Switch CONNECT Delay	1.5	_	6.5	ns
tPZL	OE to A or B				
tPHZ	Switch DISCONNECT Delay	1.5	_	5.5	ns
tPLZ	OE to A or B				
Qci	Charge Injection During Switch	_	1.5	_	рС
	DISCONNECT OE to A or B <sup>(3)</sup>				
NOTES:			·		4246 tbl 08

1. See test circuits and waveforms.

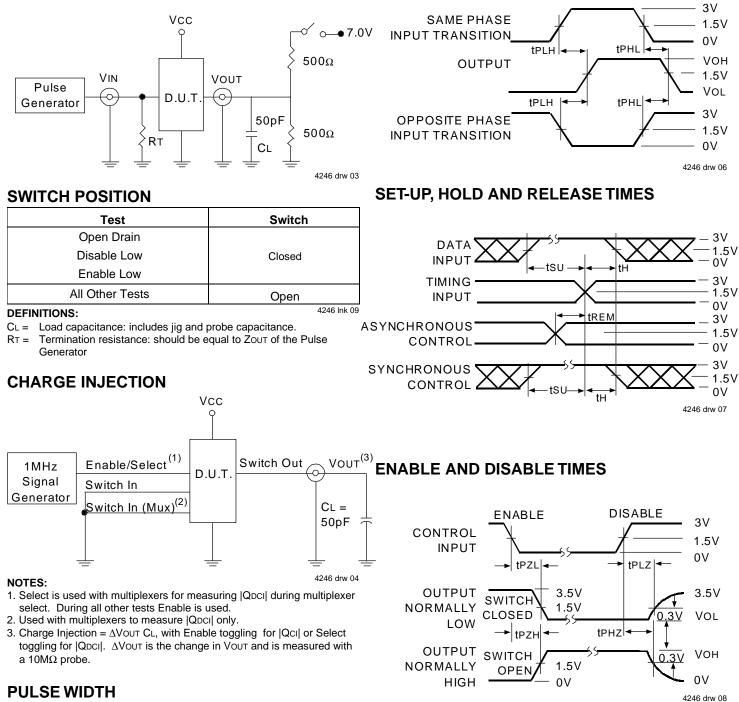
2. The bus switch contributes no Propagation Delay other than the RC Delay of the

load interacting with the RC of the switch.

|Qci| Is the charge injection for a single switch DISCONNECT and applies to either single switches or multiplexers. 3. QDcil Is the charge injection for a multiplexer as the multiplexed port switches from one path to another. Charge injection is reduced because the injection from the DISCONNECT of the first path is compensated by the CONNECT of the second path.

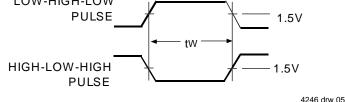
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# TEST CIRCUITS AND WAVEFORMS TEST CIRCUITS FOR ALL OUTPUTS



**PROPAGATION DELAY** 

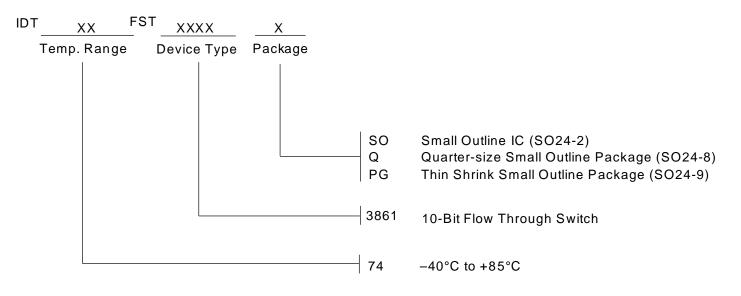
# LOW-HIGH-LOW



#### NOTES:

- 1. Diagram shown for input Control Enable-LOW and input Control Disable HIGH
- 2. Pulse Generator for All Pulses: Rate  $\leq$  1.0MHz; tF  $\leq$  2.5ns; tR  $\leq$  2.5ns

## **ORDERING INFORMATION**



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